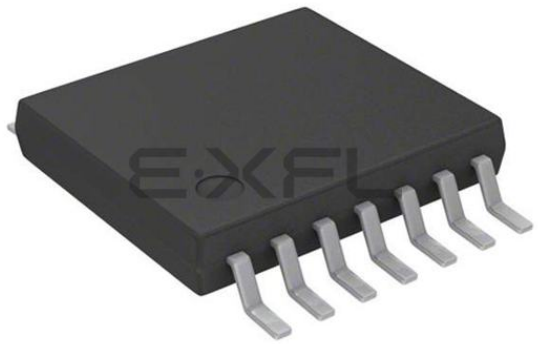

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	12
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f676t-i-st

TABLE 1-1: PIC16F630/676 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/CIN+/ICSPDAT	RA0	TTL	CMOS	Bidirectional I/O w/ programmable pull-up and interrupt-on-change.
	AN0	AN	—	A/D Channel 0 input.
	CIN+	AN		Comparator input.
	ICSPDAT	TTL	CMOS	Serial Programming Data I/O.
RA1/AN1/CIN-/VREF/ ICSPCLK	RA1	TTL	CMOS	Bidirectional I/O w/ programmable pull-up and interrupt-on-change.
	AN1	AN	—	A/D Channel 1 input.
	CIN-	AN	—	Comparator input.
	VREF	AN	—	External Voltage reference.
	ICSPCLK	ST	—	Serial Programming Clock.
RA2/AN2/COUT/T0CKI/INT	RA2	ST	CMOS	Bidirectional I/O w/ programmable pull-up and interrupt-on-change.
	AN2	AN	—	A/D Channel 2 input.
	COUT	—	CMOS	Comparator output.
	T0CKI	ST	—	Timer0 clock input.
	INT	ST	—	External Interrupt.
RA3/$\overline{\text{MCLR}}$/VPP	RA3	TTL	—	Input port with interrupt-on-change.
	$\overline{\text{MCLR}}$	ST	—	Master Clear.
	VPP	HV	—	Programming voltage.
RA4/$\overline{\text{T1G}}$/AN3/OSC2/ CLKOUT	RA4	TTL	CMOS	Bidirectional I/O w/ programmable pull-up and interrupt-on-change.
	$\overline{\text{T1G}}$	ST	—	Timer1 gate.
	AN3	AN3	—	A/D Channel 3 input.
	OSC2	—	XTAL	Crystal/Resonator.
	CLKOUT	—	CMOS	FOSC/4 output.
RA5/T1CKI/OSC1/CLKIN	RA5	TTL	CMOS	Bidirectional I/O w/ programmable pull-up and interrupt-on-change.
	T1CKI	ST	—	Timer1 clock.
	OSC1	XTAL	—	Crystal/Resonator.
	CLKIN	ST	—	External clock input/RC oscillator connection.
RC0/AN4	RC0	TTL	CMOS	Bidirectional I/O.
	AN4	AN4	—	A/D Channel 4 input.
RC1/AN5	RC1	TTL	CMOS	Bidirectional I/O.
	AN5	AN5	—	A/D Channel 5 input.
RC2/AN6	RC2	TTL	CMOS	Bidirectional I/O.
	AN6	AN6	—	A/D Channel 6 input.
RC3/AN7	RC3	TTL	CMOS	Bidirectional I/O.
	AN7	AN7	—	A/D Channel 7 input.
RC4	RC4	TTL	CMOS	Bidirectional I/O.
RC5	RC5	TTL	CMOS	Bidirectional I/O.
VSS	VSS	Power	—	Ground reference.
VDD	VDD	Power	—	Positive supply.

Legend: Shade = PIC16F676 only
TTL = TTL input buffer
ST = Schmitt Trigger input buffer

REGISTER 3-4: IOCA — INTERRUPT-ON-CHANGE PORTA REGISTER (ADDRESS: 96h)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0
bit 7							bit 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **IOCA<5:0>:** Interrupt-on-Change PORTA Control bits
1 = Interrupt-on-change enabled
0 = Interrupt-on-change disabled

Note: Global Interrupt Enable (GIE) must be enabled for individual interrupts to be recognized.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

3.2.3 PIN DESCRIPTIONS AND DIAGRAMS

Each PORTA pin is multiplexed with other functions. The pins and their combined functions are briefly described here. For specific information about individual functions such as the comparator or the A/D, refer to the appropriate section in this Data Sheet.

3.2.3.1 RA0/AN0/CIN+

Figure 3-1 shows the diagram for this pin. The RA0 pin is configurable to function as one of the following:

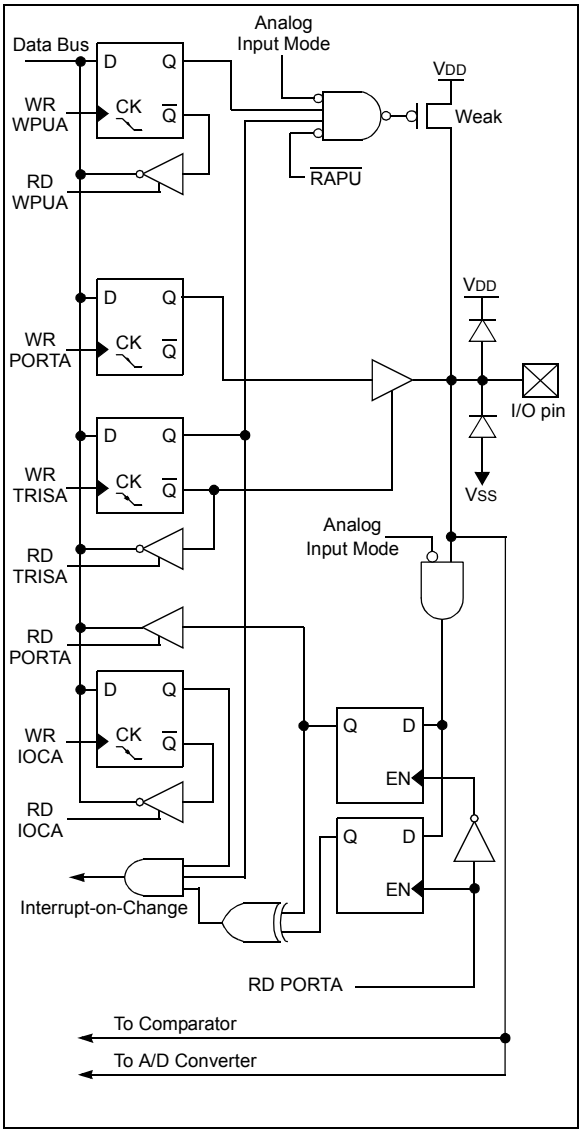
- a general purpose I/O
- an analog input for the A/D (PIC16F676 only)
- an analog input to the comparator

3.2.3.2 RA1/AN1/CIN-/VREF

Figure 3-1 shows the diagram for this pin. The RA1 pin is configurable to function as one of the following:

- as a general purpose I/O
- an analog input for the A/D (PIC16F676 only)
- an analog input to the comparator
- a voltage reference input for the A/D (PIC16F676 only)

FIGURE 3-1: BLOCK DIAGRAM OF RA0 AND RA1 PINS



3.3 PORTC

PORTC is a general purpose I/O port consisting of 6 bidirectional pins. The pins can be configured for either digital I/O or analog input to A/D converter. For specific information about individual functions such as the comparator or the A/D, refer to the appropriate section in this Data Sheet.

Note:	The ANSEL register (91h) must be clear to configure an analog channel as a digital input. Pins configured as analog inputs will read '0'. The ANSEL register is defined for the PIC16F676.

EXAMPLE 3-2: INITIALIZING PORTC

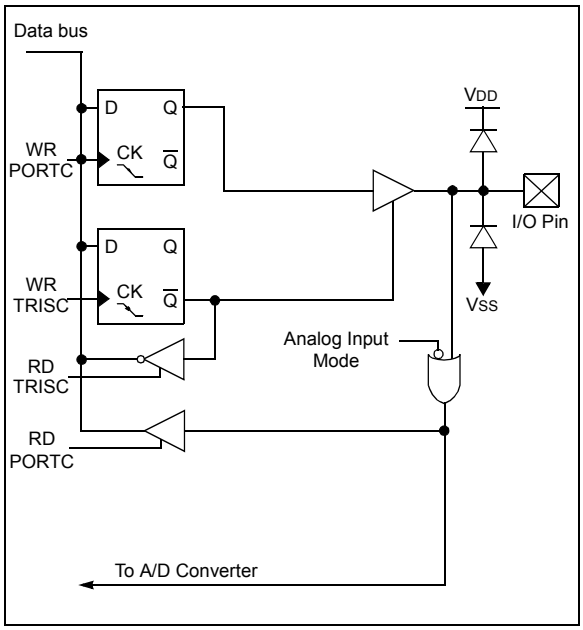
```
BCF     STATUS,RP0      ;Bank 0
CLRF    PORTC           ;Init PORTC
BSF     STATUS,RP0      ;Bank 1
CLRF    ANSEL           ;digital I/O
MOVLW   0Ch             ;Set RC<3:2> as inputs
MOVWF   TRISC           ;and set RC<5:4,1:0>
                        ;as outputs
BCF     STATUS,RP0      ;Bank 0
```

3.3.1 RC0/AN4, RC1/AN5, RC2/AN6, RC3/AN7

The RC0/RC1/RC2/RC3 pins are configurable to function as one of the following:

- a general purpose I/O
- an analog input for the A/D Converter (PIC16F676 only)

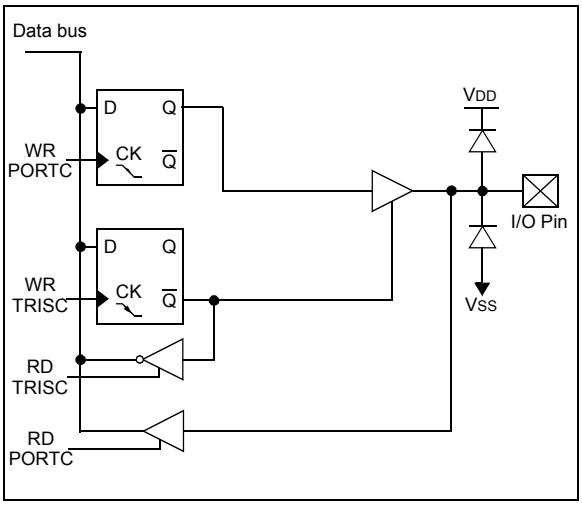
FIGURE 3-6: BLOCK DIAGRAM OF RC0/RC1/RC2/RC3 PINs



3.3.2 RC4 AND RC5

The RC4 and RC5 pins are configurable to function as a general purpose I/Os.

FIGURE 3-7: BLOCK DIAGRAM OF RC4 AND RC5 PINS



5.0 TIMER1 MODULE WITH GATE CONTROL

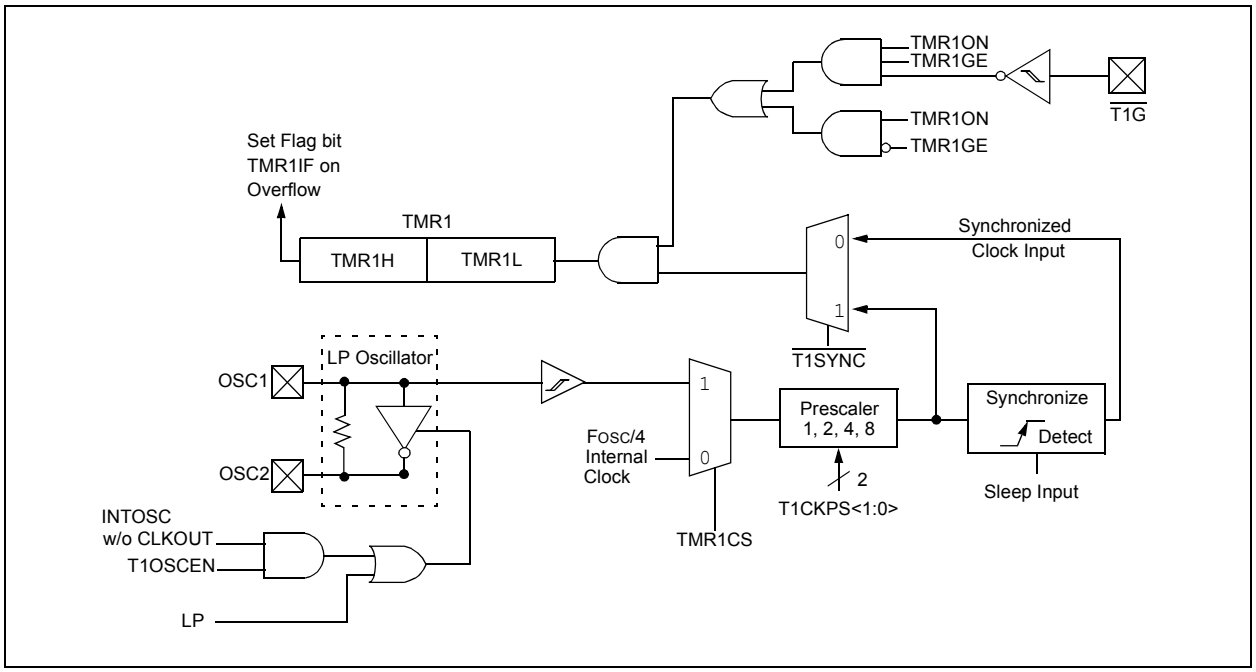
The PIC16F630/676 devices have a 16-bit timer. Figure 5-1 shows the basic block diagram of the Timer1 module. Timer1 has the following features:

- 16-bit timer/counter (TMR1H:TMR1L)
- Readable and writable
- Internal or external clock selection
- Synchronous or asynchronous operation
- Interrupt on overflow from FFFFh to 0000h
- Wake-up upon overflow (Asynchronous mode)
- Optional external enable input ($\overline{T1G}$)
- Optional LP oscillator

The Timer1 Control register (T1CON), shown in Register 5-1, is used to enable/disable Timer1 and select the various features of the Timer1 module.

Note:	Additional information on timer modules is available in the PIC® Mid-Range Reference Manual, (DS33023).

FIGURE 5-1: TIMER1 BLOCK DIAGRAM



7.3 A/D Operation During Sleep

The A/D converter module can operate during Sleep. This requires the A/D clock source to be set to the internal oscillator. When the RC clock source is selected, the A/D waits one instruction before starting the conversion. This allows the SLEEP instruction to be executed, thus eliminating much of the switching noise from the conversion. When the conversion is complete, the GO/$\overline{\text{DONE}}$ bit is cleared, and the result is loaded into the ADRESH:ADRESL registers. If the A/D interrupt is enabled, the device awakens from Sleep. If the A/D interrupt is not enabled, the A/D module is turned off, although the ADON bit remains set.

When the A/D clock source is something other than RC, a SLEEP instruction causes the present conversion to be aborted, and the A/D module is turned off. The ADON bit remains set.

7.4 Effects of Reset

A device Reset forces all registers to their Reset state. Thus, the A/D module is turned off and any pending conversion is aborted. The ADRESH:ADRESL registers are unchanged.

TABLE 7-2: SUMMARY OF A/D REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOD	Value on all other Resets
05h	PORTA	—	—	PORTA5	PORTA4	PORTA3	PORTA2	PORTA1	PORTA0	--xx xxxx	--uu uuuu
07h	PORTC	—	—	PORTC5	PORTC4	PORTC3	PORTC2	PORTC1	PORTC0	--xx xxxx	--uu uuuu
0Bh, 8Bh	INTCON	GIE	PEIE	T0IE	INTE	RAIE	T0IF	INTF	RAIF	0000 0000	0000 000u
0Ch	PIR1	EEIF	ADIF	—	—	CMIF	—	—	TMR1IF	00-- 0--0	00-- 0--0
1Eh	ADRESH	Most Significant 8 bits of the Left Shifted A/D result or 2 bits of the Right Shifted Result								xxxx xxxx	uuuu uuuu
1Fh	ADCON0	ADFM	VCFG	—	CHS2	CHS1	CHS0	GO	ADON	00-0 0000	00-0 0000
85h	TRISA	—	—	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	--11 1111	--11 1111
87h	TRISC	—	—	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	--11 1111	--11 1111
8Ch	PIE1	EEIE	ADIE	—	—	CMIE	—	—	TMR1IE	00-- 0--0	00-- 0--0
91h	ANSEL	ANS7	ANS6	ANS5	ANS4	ANS3	ANS2	ANS1	ANS0	1111 1111	1111 1111
9Eh	ADRESL	Least Significant 2 bits of the Left Shifted A/D Result or 8 bits of the Right Shifted Result								xxxx xxxx	uuuu uuuu
9Fh	ADCON1	—	ADCS2	ADCS1	ADCS0	—	—	—	—	-000 ----	-000 ----

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used for A/D converter module.

8.1 EEADR

The EEADR register can address up to a maximum of 128 bytes of data EEPROM. Only seven of the eight bits in the register (EEADR<6:0>) are required. The MSb (bit 7) is ignored.

The upper bit should always be '0' to remain upward compatible with devices that have more data EEPROM memory.

8.2 EECON1 AND EECON2 REGISTERS

EECON1 is the control register with four low order bits physically implemented. The upper four bits are non-implemented and read as '0's.

Control bits RD and WR initiate read and write, respectively. These bits cannot be cleared, only set, in software. They are cleared in hardware at completion of the read or write operation. The inability to clear the WR bit in software prevents the accidental, premature termination of a write operation.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set when a write operation is interrupted by a $\overline{\text{MCLR}}$ Reset, or a WDT Time-out Reset during normal operation. In these situations, following Reset, the user can check the WRERR bit, clear it, and rewrite the location. The data and address will be cleared, therefore, the EEDATA and EEADR registers will need to be re-initialized.

The Interrupt flag bit EEIF in the PIR1 register is set when the write is complete. This bit must be cleared in software.

EECON2 is not a physical register. Reading EECON2 will read all '0's. The EECON2 register is used exclusively in the data EEPROM write sequence.

REGISTER 8-3: EECON1 — EEPROM CONTROL REGISTER (ADDRESS: 9Ch)

U-0	U-0	U-0	U-0	R/W-x	R/W-0	R/S-0	R/S-0
—	—	—	—	WRERR	WREN	WR	RD
bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3 **WRERR:** EEPROM Error Flag bit
1 = A write operation is prematurely terminated (any $\overline{\text{MCLR}}$ Reset, any WDT Reset during normal operation or BOD detect)
0 = The write operation completed

bit 2 **WREN:** EEPROM Write Enable bit
1 = Allows write cycles
0 = Inhibits write to the data EEPROM

bit 1 **WR**: Write Control bit
1 = Initiates a write cycle (The bit is cleared by hardware once write is complete. The WR bit can only be set, not cleared, in software.)
0 = Write cycle to the data EEPROM is complete

bit 0 **RD**: Read Control bit
1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only be set, not cleared, in software.)
0 = Does not initiate an EEPROM read

Legend:			
S = Bit can only be set			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

SWAPF	Swap Nibbles in f
Syntax:	[*label*] SWAPF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f<3:0>) → (destination<7:4>), (f<7:4>) → (destination<3:0>)
Status Affected:	None
Description:	The upper and lower nibbles of register ‘f’ are exchanged. If ‘d’ is 0, the result is placed in the W register. If ‘d’ is 1, the result is placed in register ‘f’.

XORLW	Exclusive OR Literal with W
Syntax:	[*label*] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. k → (W)
Status Affected:	Z
Description:	The contents of the W register are XOR’ed with the eight-bit literal ‘k’. The result is placed in the W register.

XORWF	Exclusive OR W with f
Syntax:	[*label*] XORWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .XOR. (f) → (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register ‘f’. If ‘d’ is 0, the result is stored in the W register. If ‘d’ is 1, the result is stored back in register ‘f’.

12.4 DC Characteristics: PIC16F630/676-E (Extended)

		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D010E	**Supply Current (IDD)**	—	9	16	µA	2.0	FOSC = 32 kHz LP Oscillator Mode
		—	18	28	µA	3.0	
		—	35	54	µA	5.0	
D011E		—	110	150	µA	2.0	FOSC = 1 MHz XT Oscillator Mode
		—	190	280	µA	3.0	
		—	330	450	µA	5.0	
D012E		—	220	280	µA	2.0	FOSC = 4 MHz XT Oscillator Mode
		—	370	650	µA	3.0	
		—	0.6	1.4	mA	5.0	
D013E		—	70	110	µA	2.0	FOSC = 1 MHz EC Oscillator Mode
		—	140	250	µA	3.0	
		—	260	390	µA	5.0	
D014E		—	180	250	µA	2.0	FOSC = 4 MHz EC Oscillator Mode
		—	320	470	µA	3.0	
		—	580	850	µA	5.0	
D015E		—	340	450	µA	2.0	FOSC = 4 MHz INTOSC Mode
		—	500	780	µA	3.0	
		—	0.8	1.1	mA	5.0	
D016E		—	180	250	µA	2.0	FOSC = 4 MHz EXTRC Mode
		—	320	450	µA	3.0	
		—	580	800	µA	5.0	
D017E		—	2.1	2.95	mA	4.5	FOSC = 20 MHz HS Oscillator Mode
		—	2.4	3.0	mA	5.0	

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The test conditions for all IDD measurements in Active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\overline{MCLR}$ = VDD; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

12.5 DC Characteristics: PIC16F630/676-E (Extended)

Param No.	Device Characteristics	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended					
		Min	Typ†	Max	Units	Conditions	
						VDD	Note
D020E	Power-down Base Current (IPD)	—	0.00099	3.5	µA	2.0	WDT, BOD, Comparators, VREF, and T1OSC disabled
		—	0.0012	4.0	µA	3.0	
		—	0.0029	8.0	µA	5.0	
D021E		—	0.3	6.0	µA	2.0	WDT Current(1)
		—	1.8	9.0	µA	3.0	
		—	8.4	20	µA	5.0	
D022E		—	58	70	µA	3.0	BOD Current(1)
		—	109	130	µA	5.0	
D023E		—	3.3	10	µA	2.0	Comparator Current(1)
		—	6.1	13	µA	3.0	
		—	11.5	24	µA	5.0	
D024E		—	58	70	µA	2.0	CVREF Current(1)
		—	85	100	µA	3.0	
		—	138	165	µA	5.0	
D025E		—	4.0	10	µA	2.0	T1 OSC Current(1)
		—	4.6	12	µA	3.0	
		—	6.0	20	µA	5.0	
D026E		—	0.0012	6.0	µA	3.0	A/D Current(1)
		—	0.0022	8.5	µA	5.0	

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral current is the sum of the base IDD or IPD and the additional current consumed when this peripheral is enabled. The peripheral Δ current can be determined by subtracting the base IDD or IPD current from this limit. Max values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD.

12.9 AC CHARACTERISTICS: PIC16F630/676 (INDUSTRIAL, EXTENDED)

FIGURE 12-5: EXTERNAL CLOCK TIMING

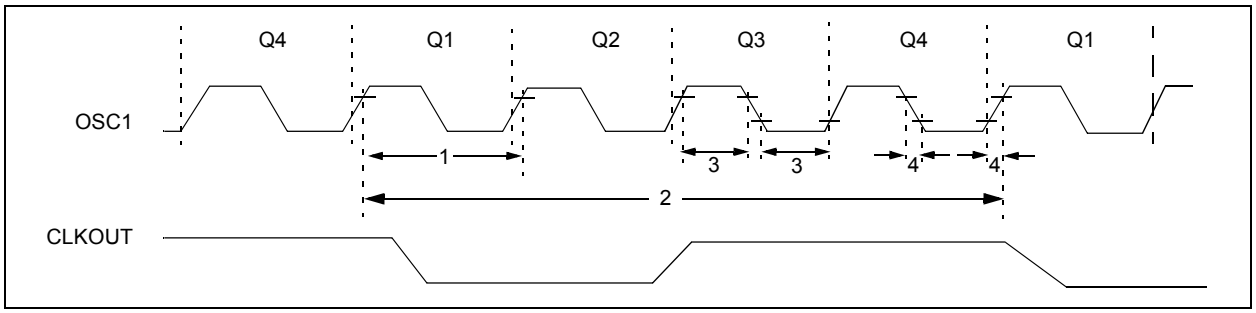


TABLE 12-1: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	FOSC	External CLKIN Frequency(1)	DC	—	37	kHz	LP Osc mode
			DC	—	4	MHz	XT mode
			DC	—	20	MHz	HS mode
			DC	—	20	MHz	EC mode
		Oscillator Frequency(1)	5	—	37	kHz	LP Osc mode
			—	4	—	MHz	INTOSC mode
			DC	—	4	MHz	RC Osc mode
			0.1	—	4	MHz	XT Osc mode
			1	—	20	MHz	HS Osc mode
1	TOSC	External CLKIN Period(1)	27	—	∞	µs	LP Osc mode
			50	—	∞	ns	HS Osc mode
			50	—	∞	ns	EC Osc mode
			250	—	∞	ns	XT Osc mode
		Oscillator Period(1)	27		200	µs	LP Osc mode
			—	250	—	ns	INTOSC mode
			250	—	—	ns	RC Osc mode
			250	—	10,000	ns	XT Osc mode
			50	—	1,000	ns	HS Osc mode
2	TCY	Instruction Cycle Time(1)	200	TCY	DC	ns	TCY = 4/FOSC
3	TosL, TosH	External CLKIN (OSC1) High External CLKIN Low	2*	—	—	µs	LP oscillator, TOSC L/H duty cycle
			20*	—	—	ns	HS oscillator, TOSC L/H duty cycle
			100 *	—	—	ns	XT oscillator, TOSC L/H duty cycle
4	TosR, TosF	External CLKIN Rise External CLKIN Fall	—	—	50*	ns	LP oscillator
			—	—	25*	ns	XT oscillator
			—	—	15*	ns	HS oscillator

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min" values with an external clock applied to OSC1 pin. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

FIGURE 12-9: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

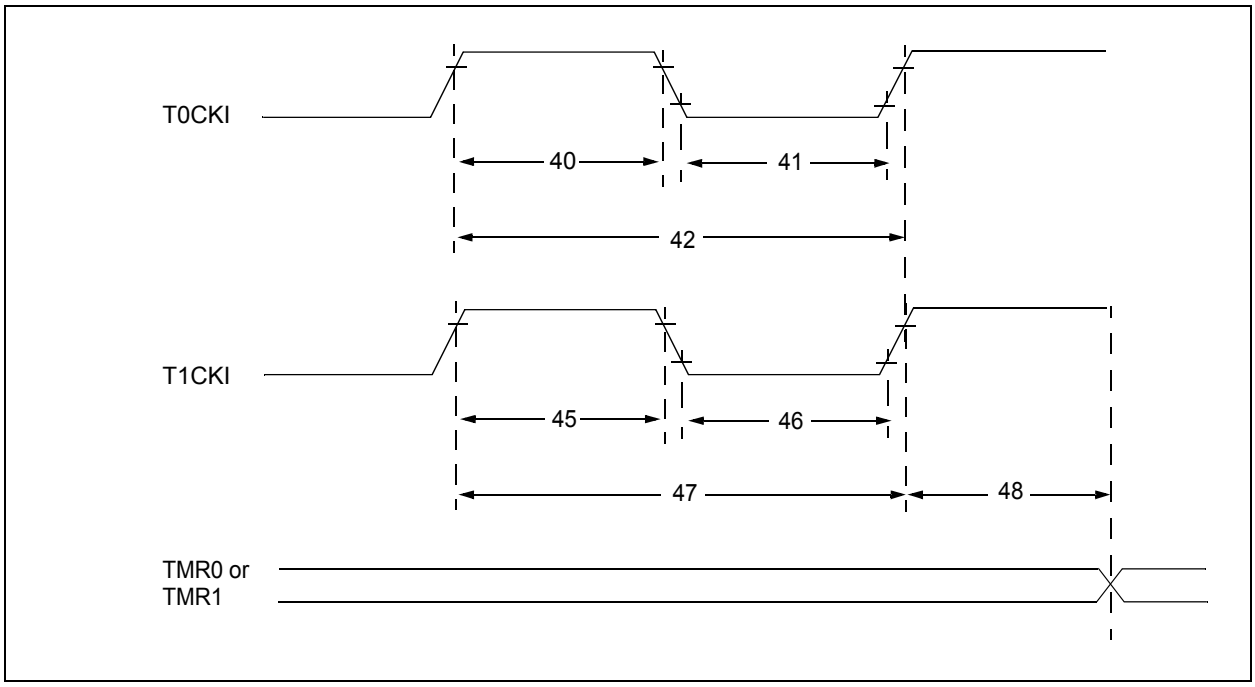


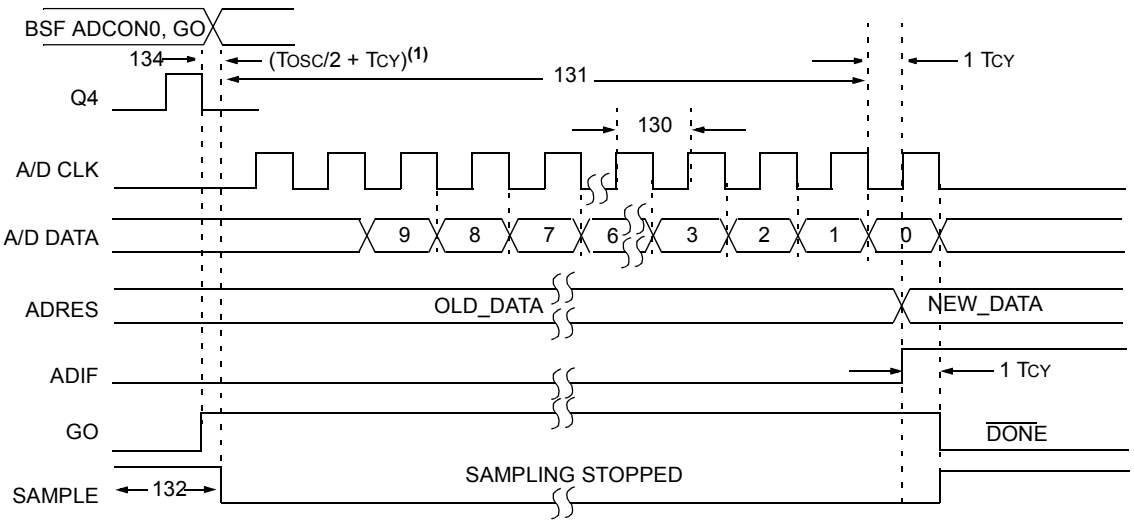
TABLE 12-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5 TCY + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5 TCY + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		Greater of: 20 or TCY + 40 / N	—	—	ns	N = prescale value (2, 4, ..., 256)
45*	Tt1H	T1CKI High Time	Synchronous, No Prescaler	0.5 TCY + 20	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, No Prescaler	0.5 TCY + 20	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
47*	Tt1P	T1CKI Input Period	Synchronous	Greater of: 30 or TCY + 40 / N	—	—	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous	60	—	—	ns	
	Ft1	Timer1 oscillator input frequency range (oscillator enabled by setting bit T1OSCEN)		DC	—	200*	kHz	
48	TCKEZtmr1	Delay from external clock edge to timer increment		2 TOSC*	—	7 TOSC*	—	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 12-11: PIC16F676 A/D CONVERSION TIMING (SLEEP MODE)



Note 1: If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

TABLE 12-10: PIC16F676 A/D CONVERSION REQUIREMENTS (SLEEP MODE)

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
130	TAD	A/D Clock Period	1.6	—	—	µs	VREF ≥ 3.0V
			3.0*	—	—	µs	VREF full range
130	TAD	A/D Internal RC Oscillator Period					ADCS<1:0> = 11 (RC mode)
			3.0*	6.0	9.0*	µs	At VDD = 2.5V
			2.0*	4.0	6.0*	µs	At VDD = 5.0V
131	TCNV	Conversion Time (not including Acquisition Time)(1)	—	11	—	TAD	
132	TACQ	Acquisition Time	**(Note 2)**	11.5	—	µs	
			5*	—	—	µs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 4.1 mV @ 4.096V) from the last sampled voltage (as stored on CHOLD).
134	TGO	Q4 to A/D Clock Start	—	TOSC/2 + TCY	—	—	If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: ADRES register may be read on the following TCY cycle.

2: See Table 7-1 for minimum conditions.

NOTES:

13.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

The graphs and tables provided in this section are for **design guidance** and are **not tested**.

In some graphs or tables, the data presented are **outside specified operating range** (i.e., outside specified VDD range). This is for **information only** and devices are ensured to operate properly only within the specified range.

The data presented in this section is a **statistical summary** of data collected on units from different lots over a period of time and matrix samples. "Typical" represents the mean of the distribution at 25°C. "Max" or "min" represents (mean + 3σ) or (mean - 3σ) respectively, where σ is standard deviation, over the whole temperature range.

FIGURE 13-1: TYPICAL IPD vs. VDD OVER TEMP (-40°C TO +25°C)

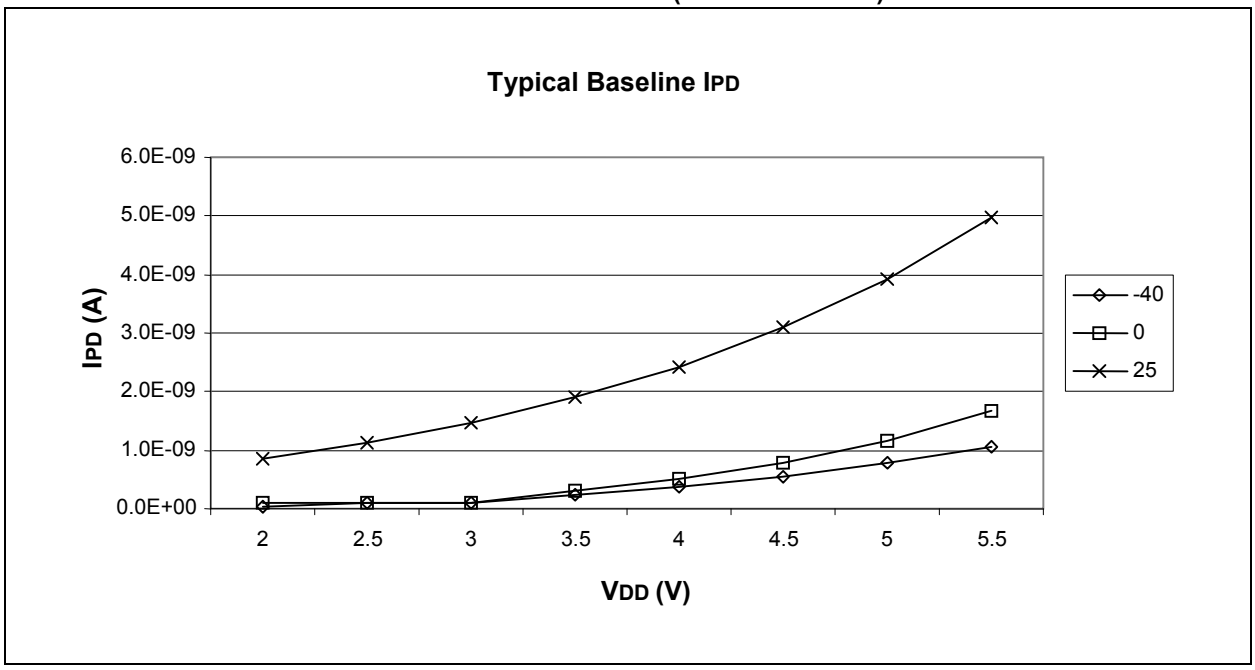


FIGURE 13-2: TYPICAL IPD vs. VDD OVER TEMP (+85°C)

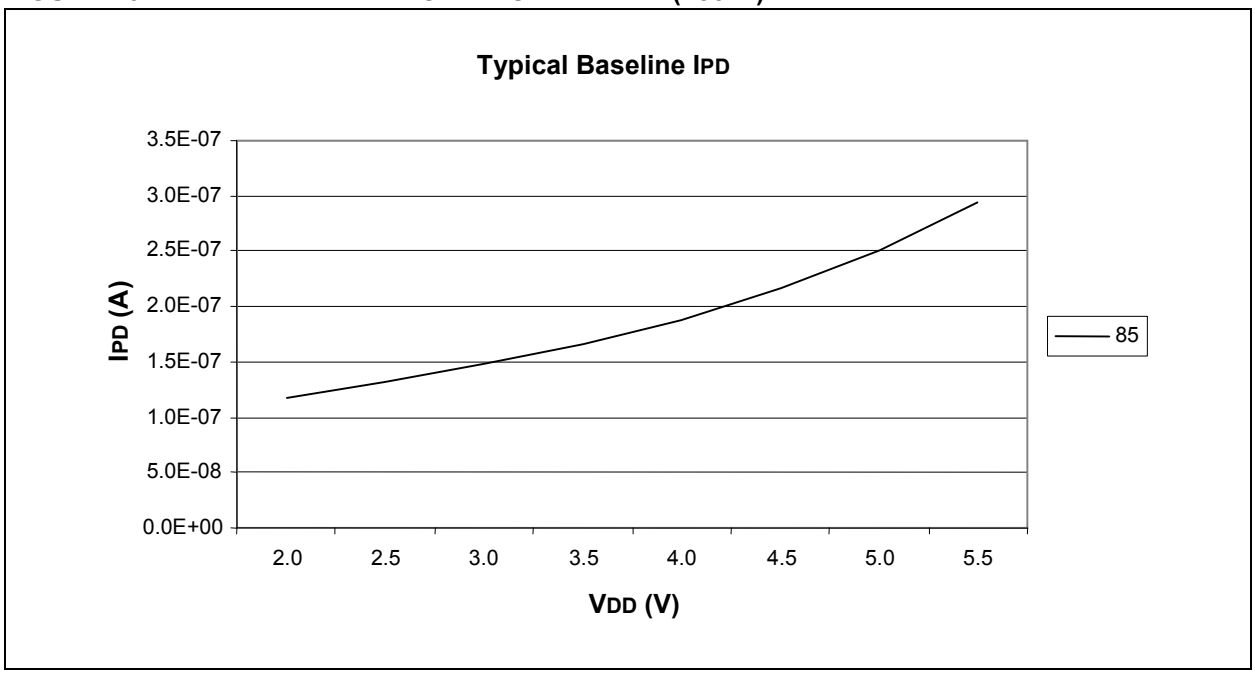


FIGURE 13-5: MAXIMUM IPD vs. VDD OVER TEMP (+85°C)

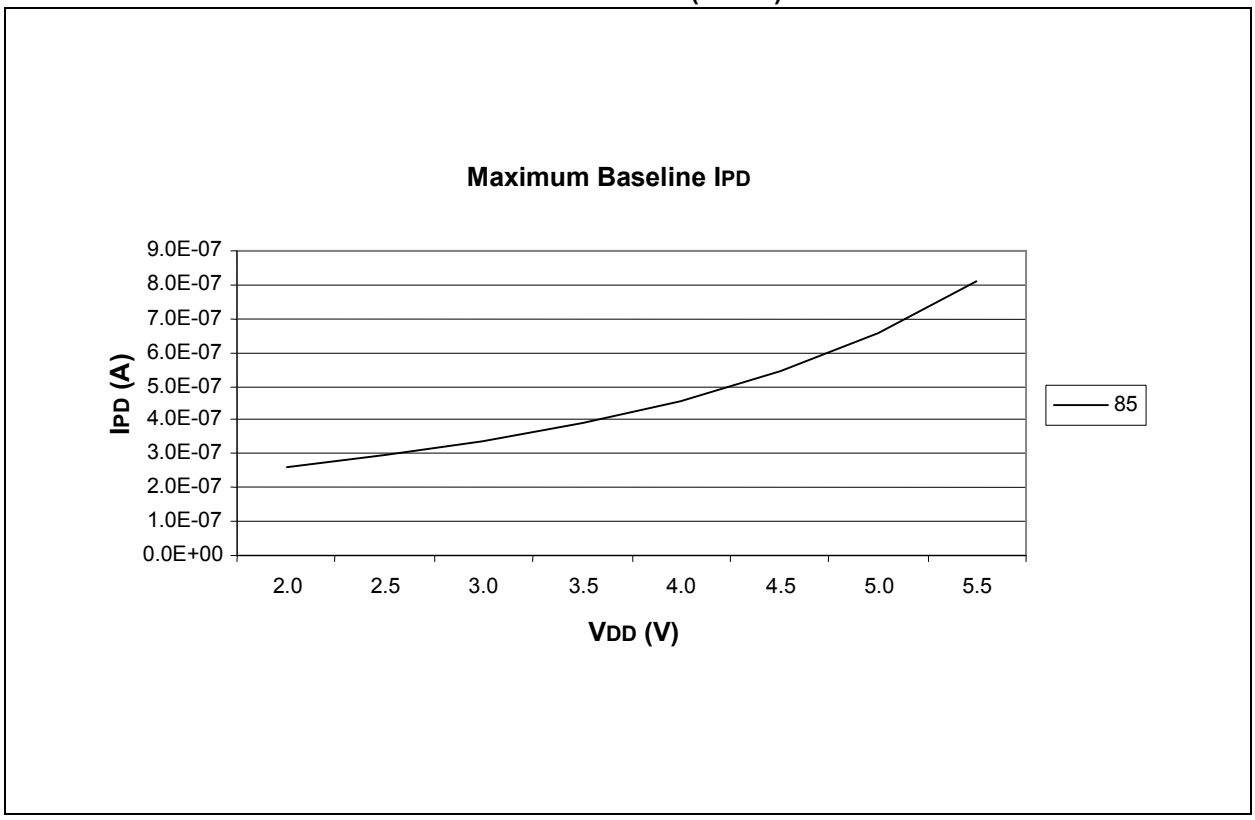
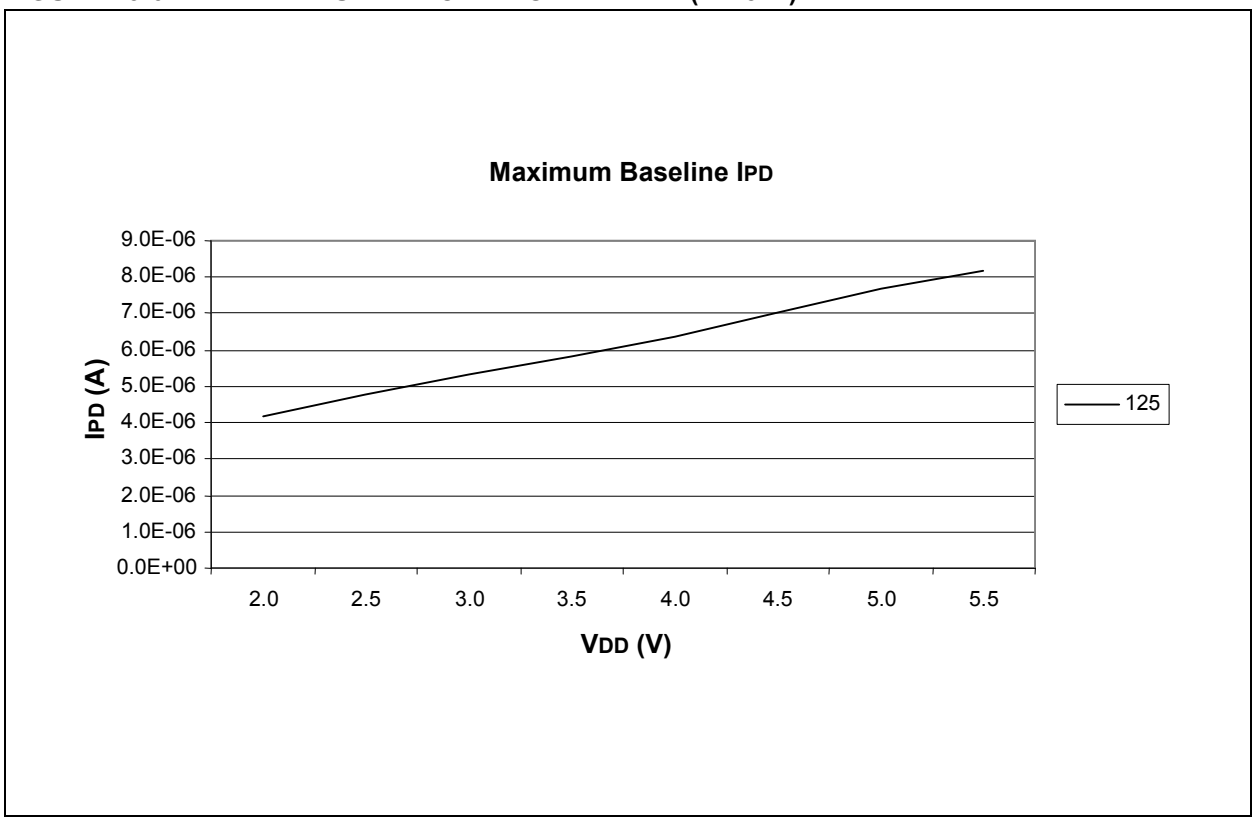


FIGURE 13-6: MAXIMUM IPD vs. VDD OVER TEMP (+125°C)



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PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	X	/XX	XXX
Device	Temperature Range	Package	Pattern

Device:	: Standard VDD range T: (Tape and Reel)	
Temperature Range:	I = -40°C to +85°C E = -40°C to +125°C	
Package:	P = PDIP SL = SOIC (Gull wing, 3.90 mm body) ST = TSSOP(4.4 mm)	
Pattern:	3-Digit Pattern Code for QTP (blank otherwise)	

Examples:

a) PIC16F630 – E/P 301 = Extended Temp., PDIP package, 20 MHz, QTP pattern #301

b) PIC16F676 – I/SL = Industrial Temp., SOIC package, 20 MHz

* JW Devices are UV erasable and can be programmed to any device configuration. JW Devices meet the electrical requirement of each oscillator type.